

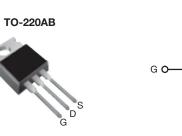
**Vishay Siliconix** 

RoHS

COMPLIANT

## **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	60			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V 0.20			
Q <sub>g</sub> (Max.) (nC)	11			
Q <sub>gs</sub> (nC)	3.1			
Q <sub>gd</sub> (nC)	5.8			
Configuration	Single			



S N-Channel MOSFET

### FEATURES

- Dynamic dV/dt Rating
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFZ14PbF
	SiHFZ14-E3
SnPb	IRFZ14
	SiHFZ14

ABSOLUTE MAXIMUM RATINGS ( $T_{C}$	= 25 °C, unl	less otherwis	se noted)				
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage <sup>f</sup>			V <sub>DS</sub>	60	V		
Gate-Source Voltage <sup>f</sup>			V <sub>GS</sub>	± 20	v		
Continuous Drain Current	V <sub>a</sub> at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	1_	10			
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	۱ <sub>D</sub>	7.2	А		
Pulsed Drain Current <sup>a</sup>	Drain Current <sup>a</sup>			40			
Linear Derating Factor				0.29	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>		E <sub>AS</sub>	47	mJ			
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		T <sub>C</sub> = 25 °C		PD	43	W
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	4.5	V/ns		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C			
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>	]		
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in		
Mounting Torque				1.1	N·m		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD}$  = 25 V; starting T<sub>J</sub> = 25 °C, L = 1.47 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 8 A (see fig. 12).

c.  $I_{SD} \leq$  10 A, dI/dt  $\leq$  90 A/µs,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq$  175 °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RAT	1	1 _				1		
PARAMETER	SYMBOL	ТҮР	•	MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		62				
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50 - - 3.5			°C/W			
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>							
SPECIFICATIONS (T <sub>J</sub> = 25 °C, u	unless otherw	vise noted)						
PARAMETER	SYMBOL	1		ONS	MIN.	TYP.	MAX.	UNIT
Static							1	1
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 25	50 µA	60	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$		e to 25 °C, I	-	-	0.063	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	-	= V <sub>GS</sub> , I <sub>D</sub> = 2		2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	-	$V_{GS} = \pm 20 V$		-	-	± 100	nA
5					-	-	25	10.0
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = 48 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$		-	-	250	μA	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		= 6.0 A <sup>b</sup>	-	-	0.20	Ω
Forward Transconductance	g <sub>fs</sub>		= 25 V, I <sub>D</sub> = 6		2.4	-	-	S
Dynamic						•		
Input Capacitance	C <sub>iss</sub>				-	300	-	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$			-	160	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	29	-		
Total Gate Charge	Qq				-	-	11	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 V$ $I_D = 10 A, V_{DS} = 48 V,$		-	-	3.1	nC	
Gate-Drain Charge	Q <sub>gd</sub>		see fig. 6 and 13 <sup>b</sup>		-	-	5.8	-
Turn-On Delay Time	t <sub>d(on)</sub>				-	10	-	
Rise Time	tr	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 10 A,		-	50	-	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	R <sub>g</sub> =	24 Ω, $R_D = 2$ see fig. 10 <sup>b</sup>	2.7 Ω,	-	13	-	- ns
Fall Time	t <sub>f</sub>	-	555 lig. 10		-	19	-	
Internal Drain Inductance	L <sub>D</sub>		Between lead, 6 mm (0.25") from		-	4.5	-	
Internal Source Inductance	L <sub>S</sub>	package and center of die contact		-	7.5	-	nH	
Drain-Source Body Diode Characteristi	cs							
Continuous Source-Drain Diode Current	١ <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10	A	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	40	τ	
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 10 A, V	V <sub>GS</sub> = 0 V <sup>b</sup>	-	-	1.6	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 05 00 1	10 4 - 11/1	H 100 A/ -b	-	70	140	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	- I <sub>J</sub> = 25 °C, I <sub>F</sub>	= 10 A, dl/d	lt = 100 A/µs <sup>b</sup>	-	0.20	0.40	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	rn-on time is	s negligible (turn	on is dor	ninated b	y L <sub>S</sub> and	Ln)

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.

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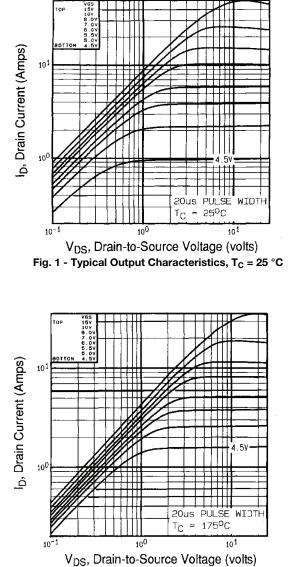


Fig. 2 - Typical Output Characteristics,  $T_c = 175$  °C

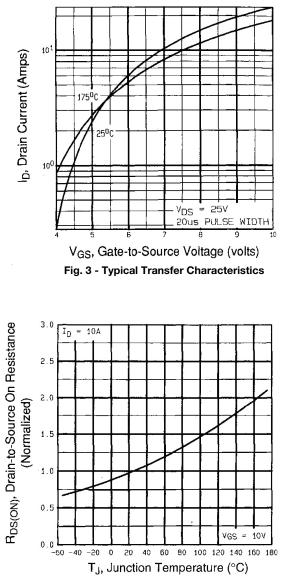
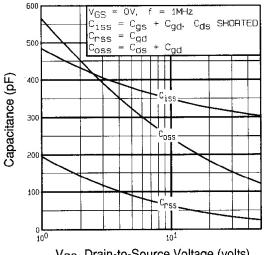


Fig. 4 - Normalized On-Resistance vs. Temperature

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V<sub>DS</sub>, Drain-to-Source Voltage (volts) Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

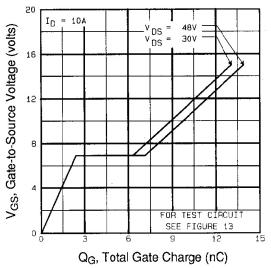
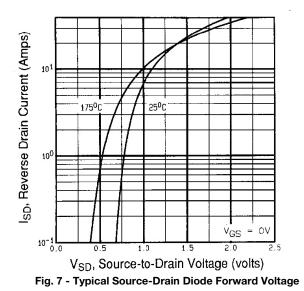
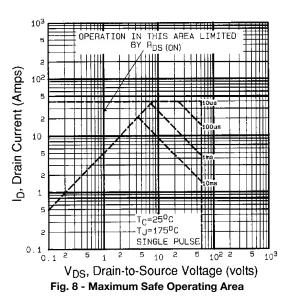


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage





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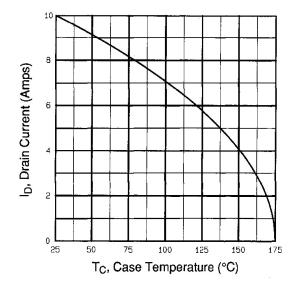


Fig. 9 - Maximum Drain Current vs. Case Temperature

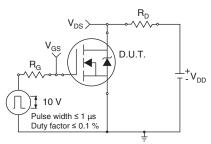


Fig. 10a - Switching Time Test Circuit

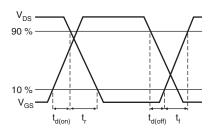
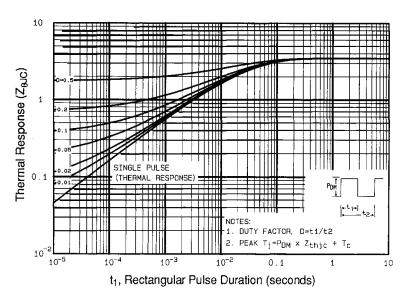
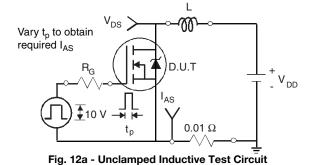


Fig. 10b - Switching Time Waveforms







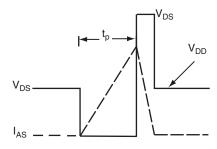


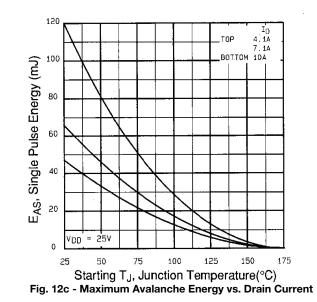
Fig. 12b - Unclamped Inductive Waveforms

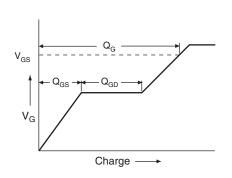
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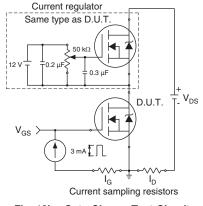
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### Peak Diode Recovery dV/dt Test Circuit

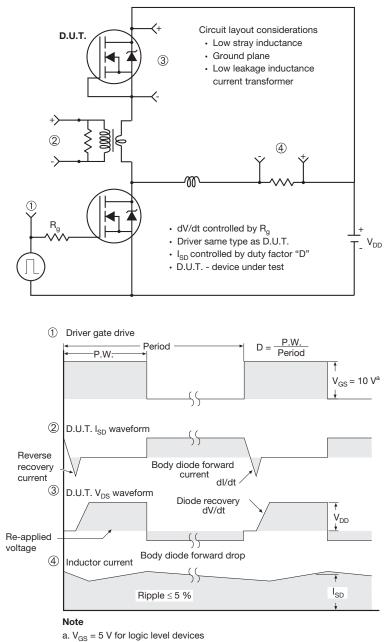


Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?91289">www.vishay.com/ppg?91289</a>.

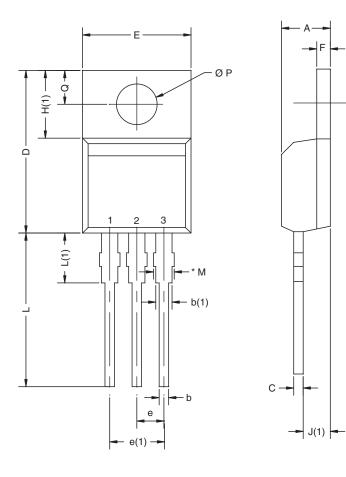
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# **Package Information**

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### TO-220AB



	MILLIMETERS		INC	CHES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
	0416-Rev. M,		0.102	0.11	

### Note

 $^{\star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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